

**AMENDMENT TRANSMITTAL LETTER (Large Entity)**

Applicant(s): Kei-Yu Ko

Docket No.  
11675.114Serial No.  
08/846,671Filing Date  
April 30, 1997Examiner  
George A. GoudreauGroup Art Unit  
1763

Invention: UNDOPED SILICON DIOXIDE AS ETCH STOP FOR SELECTIVE ETCH OF DOPED SILICON DIOXIDE

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

**RECEIVED**

SEP 25 2001

**CLAIMS AS AMENDED****TC 1700**

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	45 -	54 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	X 8 -	8 =	0 x	\$80.00	\$0.00
Multiple Dependent Claims (check if applicable)	<input type="checkbox"/>				\$0.00
					TOTAL ADDITIONAL FEE FOR THIS AMENDMENT
					\$0.00

No additional fee is required for amendment.

Please charge Deposit Account No. in the amount of  
A duplicate copy of this sheet is enclosed.

A check in the amount of to cover the filing fee is enclosed.

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 23-3178  
A duplicate copy of this sheet is enclosed.

Any additional filing fees required under 37 C.F.R. 1.16.

Any patent application processing fees under 37 CFR 1.17.

Dated: September 19, 2001



022901

PATENT TRADEMARK OFFICE

I certify that this document and fee is being deposited on with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

*Signature of Person Mailing Correspondence*

Typed or Printed Name of Person Mailing Correspondence

CC:



U.S. Express Mail Label No. EL893521051US

PATENT APPLICATION  
Docket No. 11675.114

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Kei-Yu Ko

Serial No.: 08/846,671

Filed: April 30, 1997

For: UNDOPED SILICON DIOXIDE AS ETCH  
STOP  
FOR SELECTIVE ETCH OF  
DOPED SILICON DIOXIDE

Examiner: George A. Goudreau

)  
)  
)  
)  
)  
)  
)  
)  
)  
)

#2c  
9/26/01  
MW  
RECEIVED  
SEP 25 2001  
TC 1700

AMENDMENT "D" AND RESPONSE

The Honorable Commissioner of Patents  
and Trademarks  
Washington, D. C. 20231

Sir:

In response to the Office Action dated on June 19, 2001 (the "Office Action"),  
Applicant submits this Amendment "D" and Response. Please amend the above-identified  
application as follows:

IN THE CLAIMS:

CLEAN VERSION OF THE PENDING CLAIMS Under 37 C.F.R. § 1.121(c)(3):

Please amend the claims as indicated below so that the following list presents a clean version  
of the entire set of pending claims.

Amendment "D" and Response  
Serial No.08/846,671